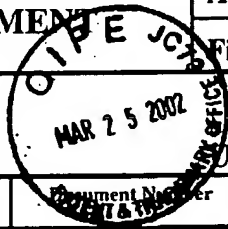


INFORMATION DISCLOSURE STATEMENT	Atty. Docket No.: 153.0074 0104	Serial No.: 10/008,645
	Applicant(s): Nemelka	Confirmation No.: 7296
	Filing Date: 9 November 2001	Group: 1741



U.S. PATENT DOCUMENTS

Examiner Initial	Copy Enclosed	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
		3,387,975	06/11/68	Tamura			
		4,592,816	06/03/86	Emmons et al.			
		4,751,172	06/14/88	Rodriguez et al.			
		4,891,110	01/02/90	Libman et al.			
		5,004,672	04/02/91	D'Ottavio et al.			
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		5,205,770	04/27/93	Lowrey et al.			
		5,232,549	08/03/93	Cathey et al.			
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	X	6,046,539	04/04/00	Haven et al.			
	X	6,153,075	11/28/00	Nemelka			

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Examiner Initial	Copy Enclosed	Document Number	Date	Country	Class	Subclass	Translation	
		NONE					Yes	No

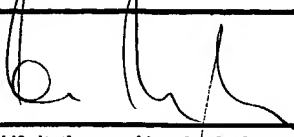
EXAMINER 	Date Considered 3/15/04
<p>*Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>	

INFORMATION DISCLOSURE STATEMENT	Atty. Docket No.: 153.0034 0104	Serial No.: 10/008,645
	Applicant(s): Nemelka	Confirmation No.: 7296
	Filing Date: 9 November 2001	Group: 1741

OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)

Examiner Initial	Copy Enclosed	Document Description
Q		Eagle®2005 Developer, Product pamphlet, Shipley Company, Inc. (1991).
		Eagle®2007 Remover, Product pamphlet, Shipley Company, Inc. (1992).
		Eagle®2100 ED Photo Resist, Product pamphlet, Shipley Company, Inc. (1992).
		Jacob, T., et al., "Liquid Resist Allows Land Size Reduction," <i>Electronic Packaging & Production</i> , 36, 27-34 (1996).
		Miller, P., "Inner-Layer Imaging Using a Novel Electrophoretic Resist," NEPCON EAST 1989 Conference, Boston, MA (1989).
		Murray, J., "ED Processes Revisted," <i>PC FAB</i> , 22-23 (1992).
		Shmulovich, J., et al., "Successful Development of Non-Planar Lithography for Micro-Machining Applications," <i>Integrated Photonics Research</i> , 6, 354-357 (1996).
V		Vidusek, D., "Electrophoretic Photoresist Technology: An Image of the Future - Today," <i>Circuit World</i> , 15, 6-10 (1989).

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**INFORMATION
DISCLOSURE
STATEMENT**

Atty. Docket No.: 150.00730104

Serial No.: 10/008,645

Applicant(s): Jefferson O. Nemelka

Confirmation No.: 7296

Application Filing Date: 9 November
2001

Group: 1741

Information Disclosure Statement mailed: September 10, 2002

U.S. PATENT DOCUMENTS

Examiner Initial	Copy Enclosed	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
6		5,827,624	10/1998	Stansbury			

FOREIGN PATENT DOCUMENTS

Examiner Initial	Copy Enclosed	Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
		None						

OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)

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		None

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EXAMINER 6	Date Considered 3/15/04
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